

PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10000252
FILING DATE 11/30/2001
CLASS 029
SUBCLASS 2812
GAU
EXAMINER Latta

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438 460

**CONTINUING DATA VERIFIED:

** FOREIGN APPLICATIONS VERIFIED:

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PG-PUB ☐ DO NOT PUBLISH ☐ RESCIND ☐
Foreign priority claimed ☐ yes ☐ no
35 USC 119 conditions met ☐ yes ☐ no
Verified and Acknowledged Examiners' initials
ATTORNEY DOCKET NO 42390P13269

TITLE : Backside metallization on microelectronic dice having beveled sides for effective thermal contact with heat dissipation device
U.S. DEPT. OF COM. /PAT & TM-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Total Claims	Print Claim for O.G.
<input type="checkbox"/> TERMINAL DISCLAIMER		Sheets Drwg.	Figs. Drwg.
		Print Fig.	
		Application Examiner	
		PREPARED FOR ISSUE	
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